



5.5GHz 1:4 FANOUT BUFFER/ TRANSLATOR w/400mV LVPECL OUTPUTS AND INTERNAL INPUT TERMINATION

Precision Edge®
SY58022U

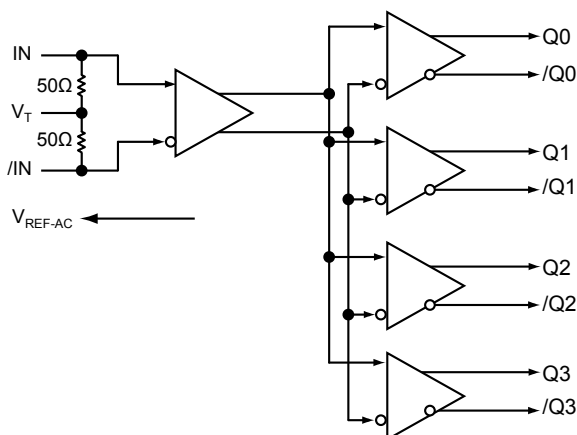
FEATURES

- Precision 1:4, 400mV LVPECL fanout buffer
- Guaranteed AC performance over temperature and voltage:
 - >5.5GHz f_{MAX} clock
 - <80ps t_r/t_f times
 - <250ps ($V_{IN} \geq 300mV$) t_{pd}
 - <15ps max. skew
- Low jitter performance:
 - <10ps_{pp} total jitter (clock)
 - <1ps_{RMS} random jitter (data)
 - <10ps_{pp} deterministic jitter (data)
- Accepts an input signal as low as 100mV
- Unique input termination and V_T pin accepts DC- and AC-coupled differential inputs: LVPECL, LVDS and CML
- 400mV LVPECL compatible outputs
- Power supply 2.5V $\pm 5\%$ and 3.3V $\pm 10\%$
- -40°C to +85°C temperature range
- Available in 16-pin (3mm $\times$ 3mm) MLF® package

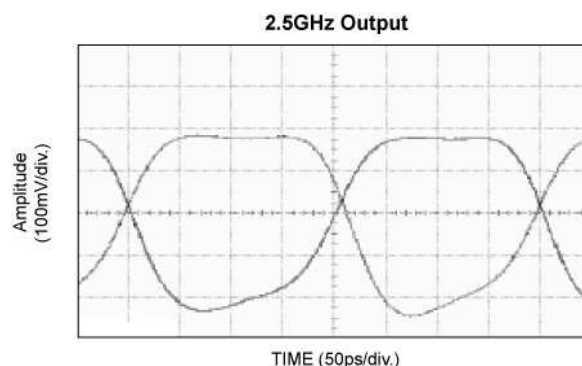
APPLICATIONS

- All SONET and All GigE clock distribution
- Fibre Channel clock and data distribution
- Backplane distribution
- Data distribution: OC-48, OC-48+FEC, XAUI
- High-end, low-skew, multiprocessor synchronous clock distribution

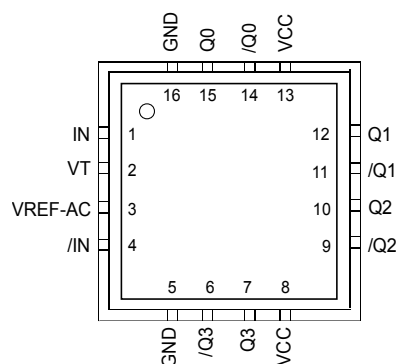
FUNCTIONAL BLOCK DIAGRAM



TYPICAL PERFORMANCE



PACKAGE/ORDERING INFORMATION

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58022UMI	MLF-16	Industrial	022U	Sn-Pb
SY58022UMITR ⁽²⁾	MLF-16	Industrial	022U	Sn-Pb
SY58022UMG	MLF-16	Industrial	022U with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY58022UMGTR ⁽²⁾	MLF-16	Industrial	022U with Pb-Free bar-line indicator	Pb-Free NiPdAu

Notes:

1. Contact factory for die availability. Die are guaranteed at $T_A = 25^\circ\text{C}$, DC electricals only.
2. Tape and Reel.

16-Pin MLF® (MLF-16)

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
1, 4	IN, /IN	Differential Input: This input pair receives the signal to be buffered. Each pin is internally terminated with 50Ω to the V_T pin. Note that this input will default to an indeterminate state if left open. See "Input Interface Applications" section.
2	VT	Input Termination Center-Tap: Each input terminates to this pin. The V_T pin provides a center-tap for each input (IN, /IN) to the termination network for maximum interface flexibility. See "Input Interface Applications" section.
3	VREF-AC	Reference Output Voltage: This output biases to $V_{CC} - 1.2\text{V}$. It is used when AC-coupling to differential inputs. Connect V_{REF-AC} directly to the V_T pin. Bypass with $0.01\mu\text{F}$ low ESR capacitor to V_{CC} . See "Input Interface Applications" section.
8, 13	VCC	Positive Power Supply: Bypass with $0.1\mu\text{F}/0.01\mu\text{F}$ low ESR capacitors as close to the pins as possible. A $0.01\mu\text{F}$ capacitor should be as close to the V_{CC} pin as possible.
5, 16	GND, Exposed Pad	Ground. Exposed pad must be connected to a ground plane that is the same potential as the ground pin.
14, 15 11, 12 9, 10 6, 7	/Q0, Q0, /Q1, Q1, /Q2, Q2, /Q3, Q3,	LVPECL Differential Output Pairs: Differential buffered output copy of the input signal. The output swing is typically 400mV. Proper termination is 50Ω to $V_{CC} - 2\text{V}$ at the receiving end. Unused output pairs may be left floating with no impact on jitter or skew. See "LVPECL Output Termination" section.

Absolute Maximum Ratings⁽¹⁾

Power Supply Voltage (V_{CC})	-0.5V to +4.0V
Input Voltage (V_{IN})	-0.5V to V_{CC}
Output Current (I_{OUT})	
Continuous	 50mA
Surge	 100mA
V_T Current	
Source or sink current on V_T pin	 ± 100 mA
Input Current	
Source or sink current on (IN, /IN)	 ± 50 mA
V_{REF} Current	
Source or sink current on V_{REF-AC} Note 4	 ± 1.5 mA
Soldering, (20 sec.)	 260°C
Storage Temperature Range (T_{STORE})	 -65 to +150°C

Operating Ratings⁽²⁾

Power Supply Voltage (V_{CC})	 +2.375V to +3.60V
Operating Temperature Range (T_A)	 -40°C to +85°C
Package Thermal Resistance	
MLF® (θ_{JA})	
Still-Air	 60°C/W
500lpfm	 54°C/W
MLF® (θ_{JB})	
(Junction-to-Board Resistance), Note 3	 33°C/W

DC ELECTRICAL CHARACTERISTICS^(Note 5) $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage	$V_{CC} = 2.5\text{V}$	2.375	2.5	2.625	V
		$V_{CC} = 3.3\text{V}$	3.0	3.3	3.60	V
I_{CC}	Power Supply Current	No load, $V_{CC} = \text{max}$		125	160	mA
V_{IH}	Input HIGH Voltage	IN, /IN, Note 6	$V_{CC}-1.6$		V_{CC}	V
V_{IL}	Input LOW Voltage	IN, /IN	0		$V_{IH}-0.1$	V
V_{IN}	Input Voltage Swing	IN, /IN; See Figure 1a	0.1		3.6	V
V_{DIFF_IN}	Differential Input Voltage	IN, /IN; See Figure 1b	0.2		3.4	V
R_{IN}	IN-to- V_T Resistance		40	50	60	Ω
V_{REF-AC}	Output Reference Voltage		$V_{CC}-1.3$	$V_{CC}-1.2$	$V_{CC}-1.1$	V
$V_{T\ IN}$	IN-to- V_T Voltage				1.28	V

LVPECL DC ELECTRICAL CHARACTERISTICS^(Note 5) $V_{CC} = 3.3\text{V} \pm 10\%$ or $V_{CC} = 2.5 \pm 5\%$; $R_L = 50\Omega$ to $V_{CC}-2\text{V}$; $T_A = -40^\circ\text{C}$ to 85°C , unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	Output HIGH Voltage		$V_{CC}-1.145$	$V_{CC}-1.020$	$V_{CC}-0.895$	V
V_{OL}	Output LOW Voltage		$V_{CC}-1.545$	$V_{CC}-1.420$	$V_{CC}-1.295$	V
V_{OUT}	Output Differential Swing	see Figure 1a	150	400	650	mV
V_{DIFF_OUT}	Differential Output Swing	see Figure 1b	300	800	1300	mV

Notes:

1. Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to ABSOLUTE MAXIMUM RATINGS conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Thermal performance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB.
4. Due to the limited drive capability, use for input of the same package only.
5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
6. $V_{IH}(\text{min.})$ not lower than 1.2V.

AC ELECTRICAL CHARACTERISTICS

$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $R_L = 50\Omega$ to $V_{CC} - 2V$; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Operating Frequency	$V_{OUT} \geq 200mV$ Clock	5.5			GHz
		NRZ Data		10		Gbps
t_{pd}	Propagation Delay		130	200	280	ps
t_{CHAN}	Channel-to-Channel Skew	Note 7		4	15	ps
t_{SKEW}	Part-to-Part Skew	Note 8			50	ps
t_{JITTER}	Clock Cycle-to-Cycle Jitter	Note 9			1	ps _{RMS}
	Total Jitter	Note 10			10	ps _{PP}
	Data Random Jitter	Note 11 2.5Gbps – 3.2Gbps			1	ps _{RMS}
	Deterministic Jitter	Note 12 2.5Gbps – 3.2Gbps			10	ps _{PP}
t_r, t_f	Output Rise/Fall Time 20% to 80%	At full swing	20	50	80	ps

Notes:

7. Skew is measured between outputs of the same bank under identical transitions.
8. Skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.
9. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, $T_n - T_{n-1}$ where T is the time between rising edges of the output signal.
10. Total jitter definition: with an ideal clock input of frequency $\leq f_{MAX}$, no more than one output edge in 10^{12} output edges will deviate by more than the specified peak-to-peak jitter value.
11. Random jitter is measured with a K28.7 comma detect character pattern, measured at 2.5Gbps/3.2Gbps.
12. Deterministic jitter is measured at 2.5Gbps/3.2Gbps with both K28.5 and $2^{23}-1$ PRBS pattern.

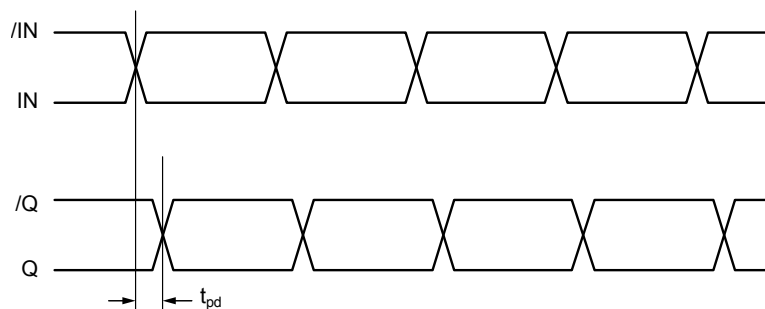
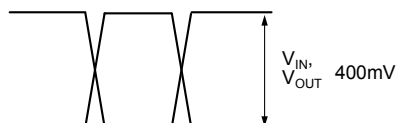
TIMING DIAGRAM**SINGLE-ENDED AND DIFFERENTIAL SWINGS**

Figure 1a. Single-Ended Swing

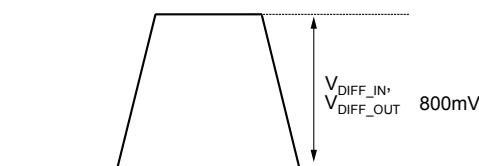
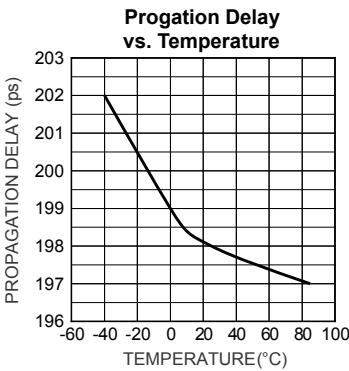
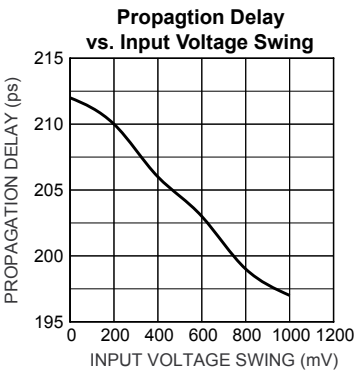
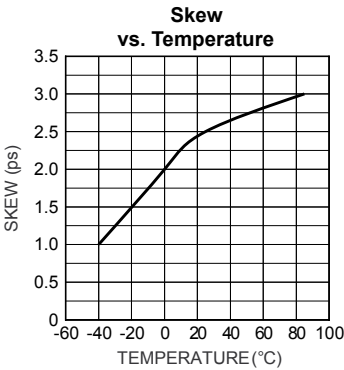
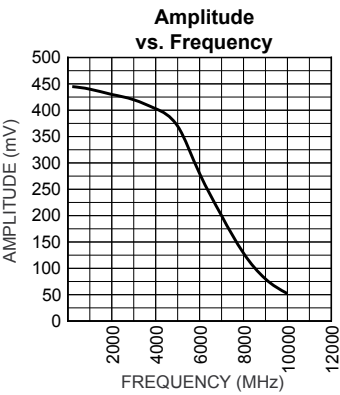


Figure 1b. Differential Swing

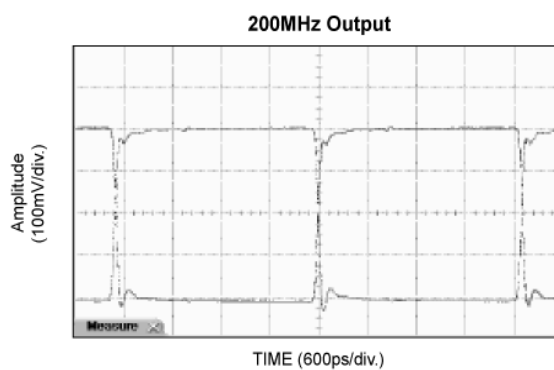
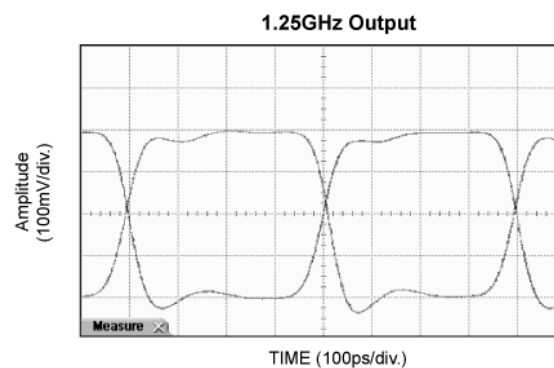
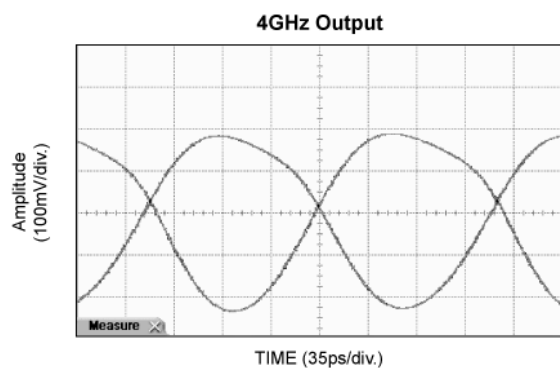
TYPICAL OPERATING CHARACTERISTICS

$V_{CC} = 3.3V$, $V_{EE} = 0V$, $V_{IN} = 100mV$, $T_A = 25^{\circ}C$, unless otherwise stated.



FUNCTIONAL CHARACTERISTICS

$V_{CC} = 3.3V$, $V_{EE} = 0V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise stated.



INPUT STAGE

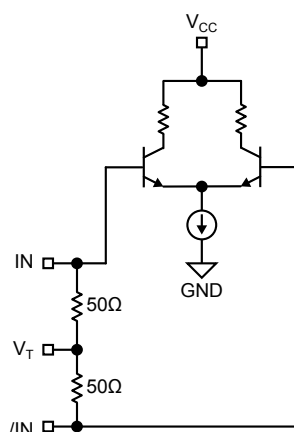


Figure 2. Simplified Differential Input Buffer

INPUT INTERFACE APPLICATIONS

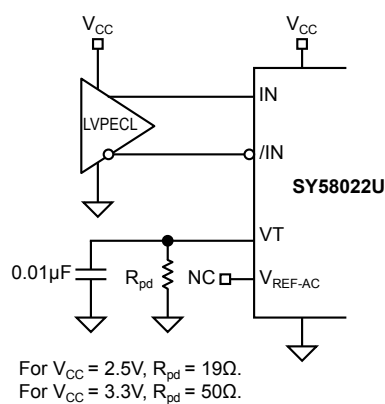


Figure 3a. DC-Coupled
LVPECL Input Interface

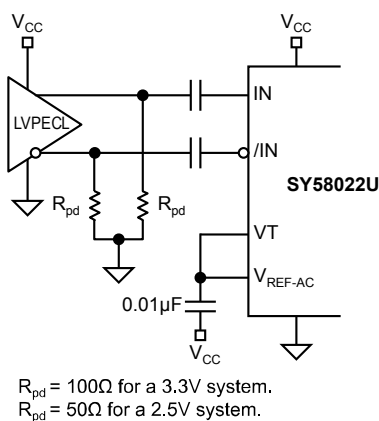


Figure 3b. AC-Coupled
LVPECL Input Interface

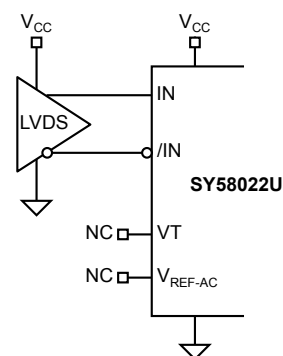


Figure 3c. LVDS
Input Interface

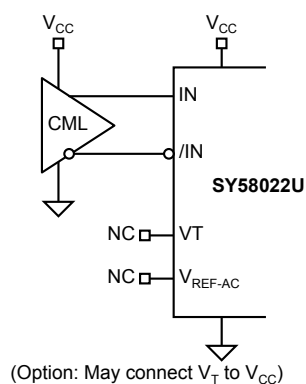


Figure 3d. AC-Coupled
CML Input Interface

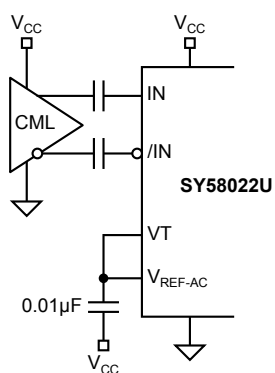


Figure 3e. CML
Input Interface

OUTPUT TERMINATION RECOMMENDATIONS

LVPECL outputs have very low output impedance (open emitter), and small signal swing which results in low EMI (electro-magnetic interference). The LVPECL is ideal for driving 50Ω- and 100Ω-controlled impedance transmission lines. In addition, LVPECL is compatible for driving standard

PECL inputs since PECL inputs require only 100mV input swing. Further, there are several techniques in terminating the LVPECL outputs, as shown in Figure 4 through 6.

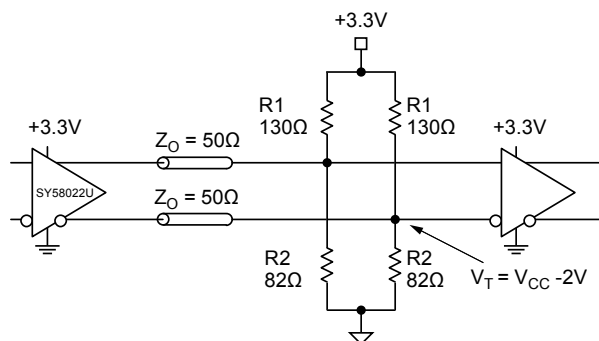


Figure 4. Parallel Termination–Thevenin Equivalent

Notes:

1. For +2.5V systems: R1 = 250Ω, R2 = 62.5Ω.
2. For +3.3V systems: R1 = 130Ω, R2 = 83Ω.

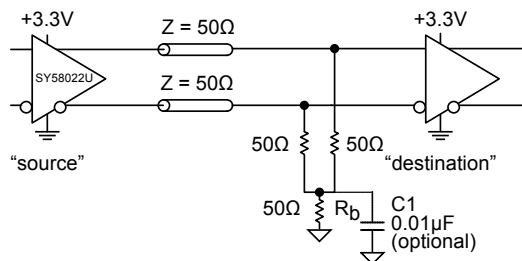


Figure 5. Three-Resistor "Y-Termination"

Notes:

1. Power-saving alternative to Thevenin termination.
2. Place termination resistors as close to destination inputs as possible.
3. R_b resistor sets the DC bias voltage, equal to V_T .
For +2.5V systems $R_b = 19Ω$.
For +3.3V systems $R_b = 46Ω$ to $50Ω$.
4. C1 is an optional bypass capacitor intended to compensate for any t_f/t_r mismatches.

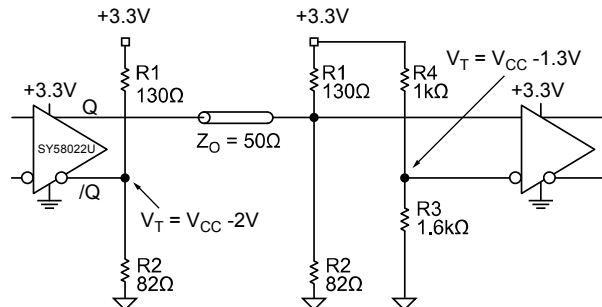


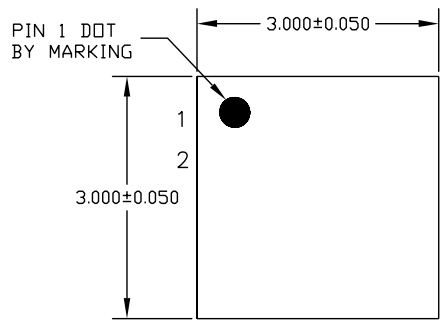
Figure 6. Terminating Unused I/O

Notes:

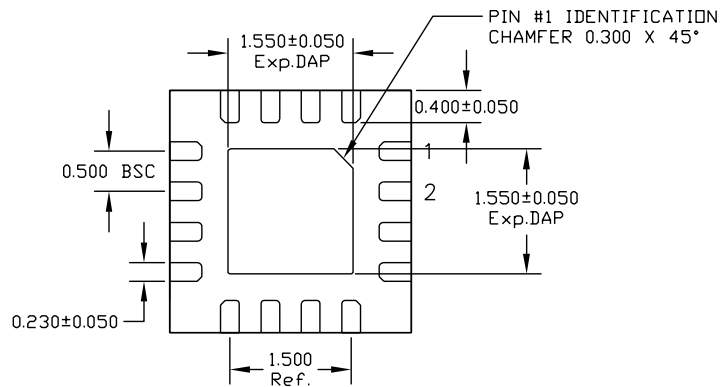
1. Unused output (/Q) must be terminated to balance the output.
2. For +2.5V systems: R1 = 250Ω, R2 = 62.5Ω, R3 = 1.25kΩ, R4 = 1.2kΩ.
For +3.3V systems: R1 = 130Ω, R2 = 82Ω, R3 = 1kΩ, R4 = 1.6kΩ.
3. Unused output pairs (Q and /Q) may be left floating.

RELATED MICREL PRODUCTS AND SUPPORT DOCUMENTATION

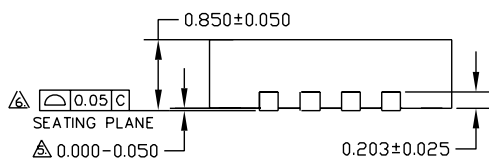
Part Number	Function	Data Sheet Link
SY58020U	6GHz, 1:4 CML Fanout Buffer/Translator Internal I/O Termination	http://www.micrel.com/product-info/products/sy58020u.shtml
SY58021U	4GHz, 1:4 LVPECL Fanout Buffer/Translator with Internal Termination	http://www.micrel.com/product-info/products/sy58021u.shtml
SY58022U	5.5GHz, 1:4 Fanout Buffer/Translator w/400mV LVPECL Outputs and Internal Input Termination	http://www.micrel.com/product-info/products/sy58022u.shtml
	16-MLF® Manufacturing Guidelines Exposed Pad Application Note	www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf
M-0317	HBW Solutions	http://www.micrel.com/product-info/as/solutions.shtml

16-PIN MicroLeadFrame® (MLF-16)

TOP VIEW



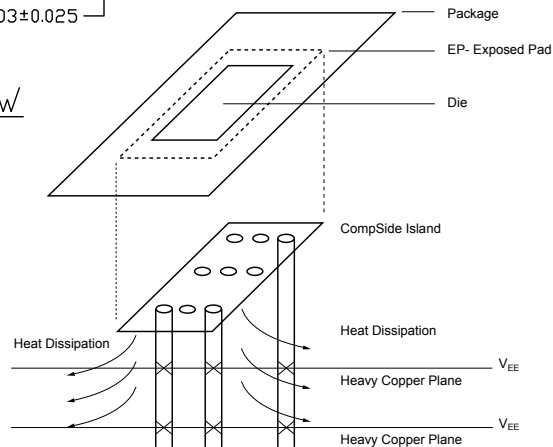
BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. MAX. PACKAGE WARPAGE IS 0.05 mm.
 3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.
- △ APPLIED ONLY FOR TERMINALS.
△ APPLIED FOR EXPOSED PAD AND TERMINALS.



PCB Thermal Consideration for 16-Pin MLF® Package
(Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB <http://www.micrel.com>

The information furnished by Micrel in this datasheet is believed to be accurate and reliable. However, no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is at Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.